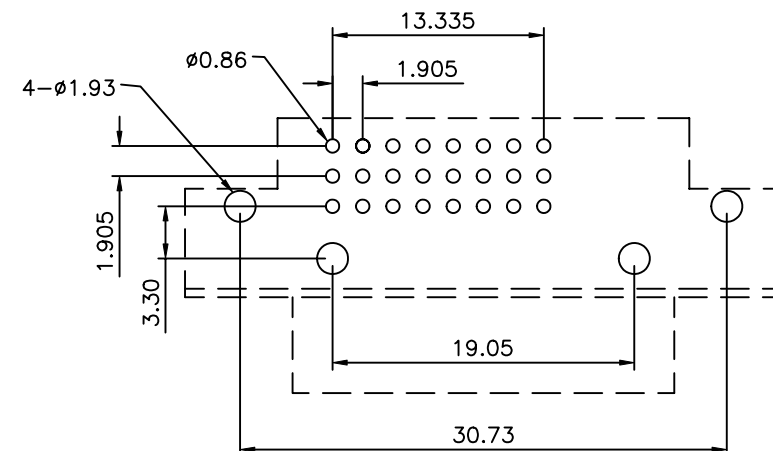
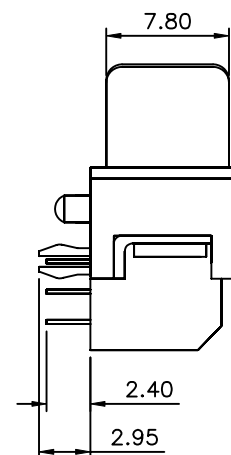
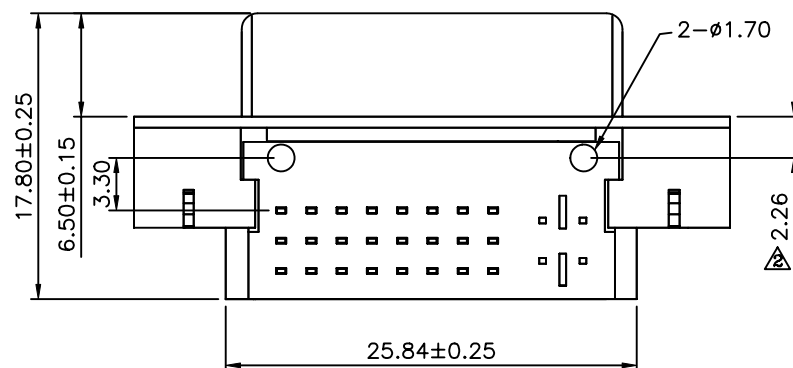
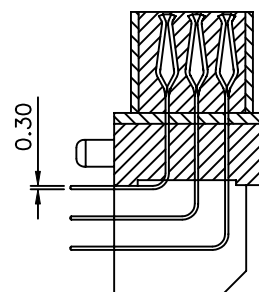
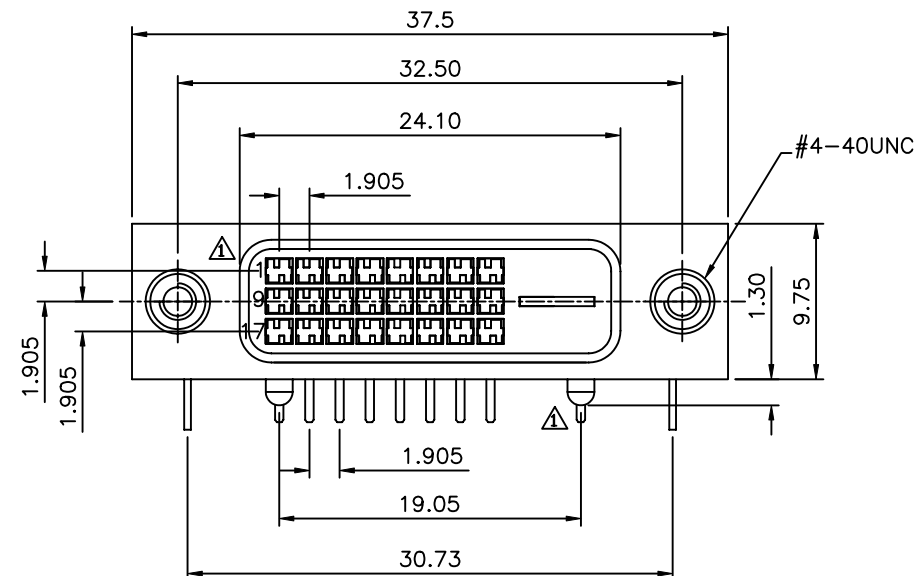


SPECIFICATION

Insulation Resistance:1000 Megaohms Min.
 Contact Resistance:30 Milliohms Max.
 Dielectric Voltage:500V DC
 Temperature Range:-20°C~+85°C
 Housing:PBT+30%GF,White
 Back Cover:PA66+30%GF,White
 Contact:Bronze,Nickel UnderPlated,
 Gold Plated On Contact Area,Tin on Solder Area
 Shell:SPCC,Nickel Plated Over Cu
 Boardlock:SPCC,Tin Plated
 RoHS Compliant



P.C.B Layout

4UCON 元化興業股份有限公司
 4UCON TECHNOLOGY INC.

DRAWING No.

09400

APPROVED BY

MEI

CHECKED BY

HZF

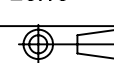
DRAWING BY

XYH

UNLESS OTHERWISE SPECIFIED

TOLERANCES ARE
 .X ±0.20
 .XX ±0.15
 .XXX ±0.10
 ANG:

UNIT
 mm



NO.	REV.	REVISIONS	CHK	DATE
△A2		Add Dim 2.26	HZF	04/20/2009
△A1		Modify Data	HZF	04/14/2009
△A0		NEW RELEASE	HZF	02/22/2008

SCALE NONE

REV.

A2